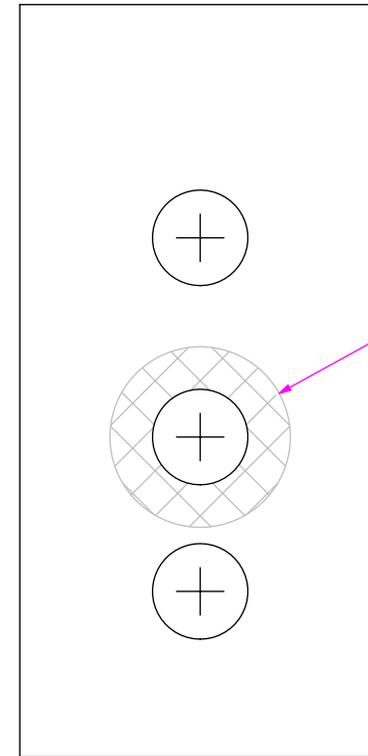


FIG 1 (FRONT VIEW)



BACK VIEW

KEEP OUT ZONE
Ø 6.00 [.236]
(SEE NOTE 2)

NOTES:

1. SEE APPLICATION SPECIFICATION AND EBX FOOTPRINT DRAWINGS FOR INFORMATION REGARDING PCB LAYOUT OF GUIDE MODULES RELATIVE TO SIGNAL MODULES.
2. DO NOT PUT TOP LEVEL TRACES OR VIAS IN THESE KEEP OUT ZONES. GUIDE MODULE USES AN M3 SCREW. IF SCREW HAS AN OUTSIDE DIAMETER LARGER THAN 6.0MM, THEN ADDITIONAL CLEARANCE WILL BE REQUIRED FOR THE BOTTOM OF THE PCB.
3. 1.60 [.063] MIN BOARD THICKNESS



ALL DIMENSIONS ARE SYMMETRIC ABOUT THE CENTERLINE.

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